#### Nch 30V 3.5A Power MOSFET

V <sub>DSS</sub>	30V
R <sub>DS(on)</sub> (Max.)	37mΩ
I <sub>D</sub>	±3.5A
P <sub>D</sub>	1W

#### Features

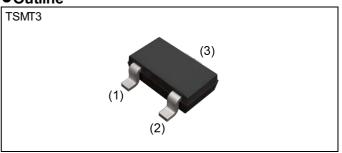
- 1) Low on resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small Surface Mount Package (TSMT3).
- 4) Pb-free lead plating; RoHS compliant

# Application

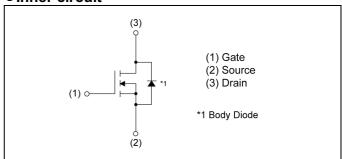
Switching

● Absolute maximum ratings (I <sub>a</sub> = 25°C)					
Symbol	Value	Unit			
V <sub>DSS</sub>	30	V			
I <sub>D</sub> *1	±3.5	А			
I <sub>D,pulse</sub> *2	±12	А			
$V_{GSS}$	±20	V			
E <sub>AS</sub> *3	1.9	mJ			
I <sub>AS</sub> *3	3.5	Α			
P <sub>D</sub> *4	1	W			
T <sub>j</sub> _	150	°C			
T <sub>stg</sub>	-55 to +150	°C			
	V <sub>DSS</sub> I <sub>D</sub> *1  I <sub>D,pulse</sub> *2  V <sub>GSS</sub> E <sub>AS</sub> *3  I <sub>AS</sub> *3  P <sub>D</sub> *4  T <sub>j</sub>	$\begin{array}{c ccccc} & V_{DSS} & 30 & & & \\ & I_{D}^{*1} & \pm 3.5 & & \\ & I_{D,pulse}^{*2} & \pm 12 & & \\ & V_{GSS} & \pm 20 & & \\ & E_{AS}^{*3} & 1.9 & & \\ & I_{AS}^{*3} & 3.5 & & \\ & P_{D}^{*4} & 1 & & \\ & T_{j} & 150 & & \\ \end{array}$			

#### Outline



#### •Inner circuit



Packaging specifications

	Packing	Embossed Tape
	Reel size (mm)	180
Туре	Tape width (mm)	8
	Basic ordering unit (pcs)	3000
	Taping code	TCL
	Marking	ZS

#### ●Thermal resistance

Parameter	Symbol	Values		Unit	
Parameter		Min.	Тур.	Max.	Uniit
Thermal resistance, junction - ambient	R <sub>thJA</sub> *4	-	125	-	°C/W

## ● Electrical characteristics (T<sub>a</sub> = 25°C)

Davamatav	Cymahal	Conditions		Values		Lloit	
Parameter	Symbol Conditions —		Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0V, I_D = 1mA$	30	-	-	V	
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	I <sub>D</sub> = 1mA referenced to 25°C	-	20.84	-	mV/°C	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V	-	-	1	μA	
Gate - Source leakage current	I <sub>GSS</sub>	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$	-	-	±100	nA	
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 1mA$	1.0	-	2.5	V	
Gate threshold voltage temperature coefficient	$\frac{\DeltaV_{GS(th)}}{\DeltaT_j}$	I <sub>D</sub> = 1mA referenced to 25°C	-	-3.25	-	mV/°C	
Static drain - source	D *5	V <sub>GS</sub> = 10V, I <sub>D</sub> = 3.5A	-	28	37	m0	
on - state resistance	R <sub>DS(on)</sub> *5	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 3.5A	-	43	56	mΩ	
Gate input resistance	R <sub>G</sub>		-	2.8	-	Ω	
Transconductance	9 <sub>fs</sub> *5	$V_{DS} = 5V, I_{D} = 3.5A$	2.4	-	-	S	

<sup>\*1</sup> Limited only by maximum temperature allowed.

<sup>\*2</sup> Pw  $\leq$  10µs, Duty cycle  $\leq$  1%

<sup>\*3</sup> L  $\simeq$  200 $\mu$ H, V<sub>DD</sub> = 15V, R<sub>G</sub> = 25 $\Omega$ , STARTING T<sub>ch</sub> = 25 $^{\circ}$ C Fig.3-1,3-2

<sup>\*4</sup> Mounted on a ceramic boad (30×30×0.8mm)

<sup>\*5</sup> Pulsed

# ●Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions		Unit		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	250	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15V	-	40	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	1	35	ı	
Turn - on delay time	$t_{d(on)}^{*5}$	$V_{DD} \simeq 15V, V_{GS} = 10V$	-	5.5		
Rise time	<b>t</b> <sub>r</sub> *5	I <sub>D</sub> = 1.75A	-	7.5	-	no
Turn - off delay time	t <sub>d(off)</sub> *5	$R_L = 8.6\Omega$		10	·	ns
Fall time	<b>t</b> <sub>f</sub> *5	$R_G = 10\Omega$	-	3.5	-	

# • Gate charge characteristics $(T_a = 25^{\circ}C)$

Davamatav	Cymah al	Conditi			Values		Unit
Parameter	Symbol Conditions		Min.	Тур.	Max.	Offic	
Total gate charge	<b>○</b> *5		V <sub>GS</sub> = 10V	-	6.0	-	
Total gate charge	$Q_g^{*5}$	V <sub>DD</sub> ≃ 15V		-	3.1	-	0
Gate - Source charge	Q <sub>gs</sub> *5	I <sub>D</sub> = 4.5A	V <sub>GS</sub> = 4.5V	-	1.2	-	nC
Gate - Drain charge	Q <sub>gd</sub> *5			-	1.1	-	

# ● Body diode electirical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions		Values	_	Unit
	Symbol	Conditions	Min.	Тур.	Max.	Offic
Body diode continuous forward current	I <sub>S</sub> *1	T - 25°C	-	1	0.8	^
Body diode pulse current	I <sub>SP</sub> *2	T <sub>a</sub> = 25°C	-	-	12	A
Forward voltage	V <sub>SD</sub> *5	$V_{GS} = 0V, I_S = 0.8A$	-	-	1.2	V

Fig.1 Typical Output Characteristics(I)

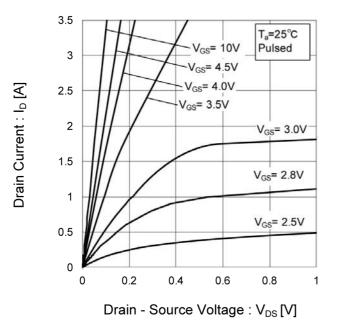
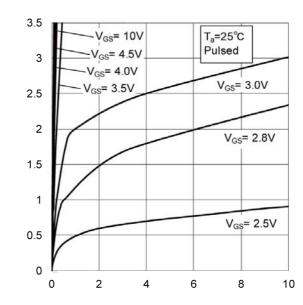


Fig.2 Typical Output Characteristics(II)

Drain Current : I<sub>D</sub> [A]



Drain - Source Voltage : V<sub>DS</sub> [V]

Fig.3 Breakdown Voltage vs. Junction Temperature

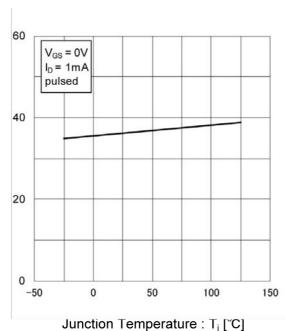


Fig.4 Typical Transfer Characteristics

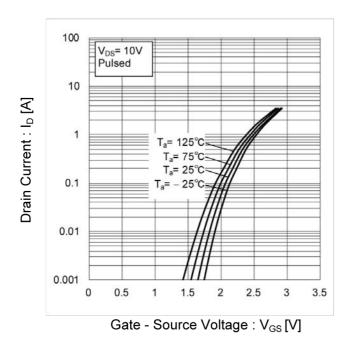
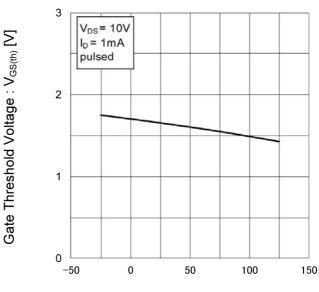


Fig.5 Gate Threshold Voltage vs. Junction Temperature



Junction Temperature : T<sub>j</sub> [°C]

Fig.6 Transconductance vs. Drain Current

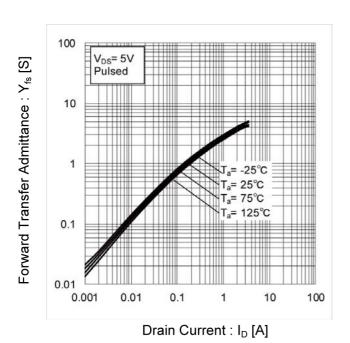


Fig.7 Drain Current Derating Curve

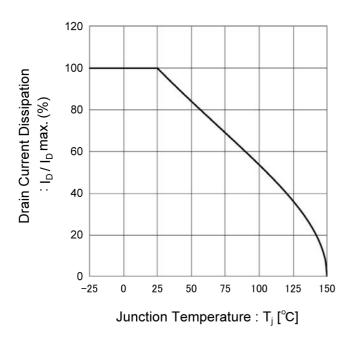


Fig.8 Static Drain - Source On - State Resistance vs. Gate Source Voltage

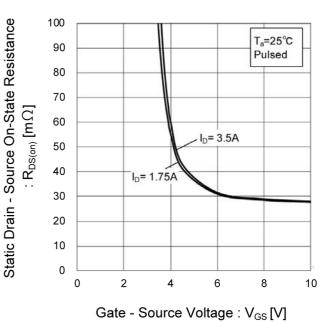
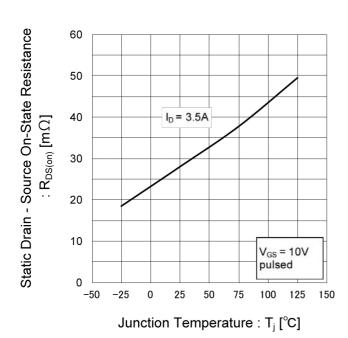


Fig.9 Static Drain - Source On - State Resistance vs. Junction Temperature



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RQ5E035BN

#### • Electrical characteristic curves

Fig.10 Static Drain - Source On - State Resistance vs. Drain Current(I)

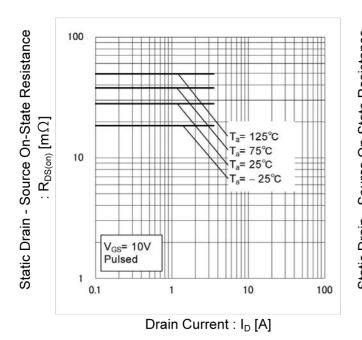
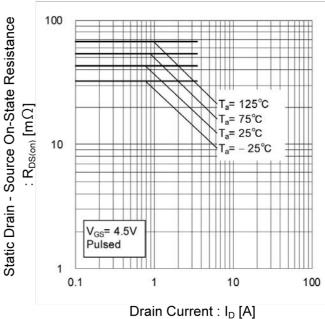


Fig.11 Static Drain - Source On - State Resistance vs. Drain Current(II)



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Fig.12 Typical Capacitance vs. Drain - Source Voltage

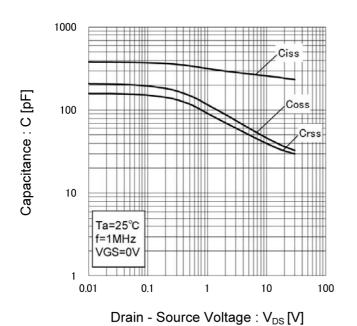
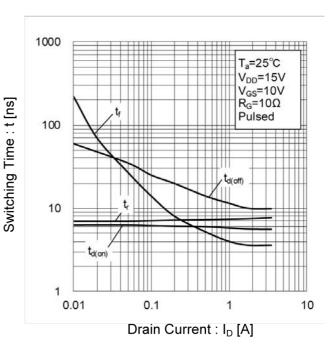


Fig.13 Switching Characteristics



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Fig.14 Dynamic Input Characteristics

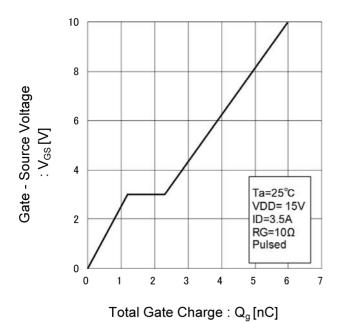
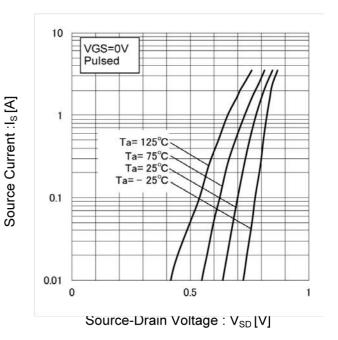


Fig.15 Source Current vs. Source Drain Voltage



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### Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

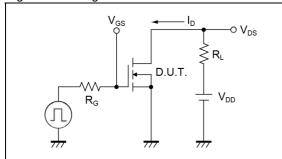


Fig.2-1 Gate Charge Measurement Circuit

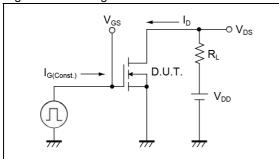


Fig.3-1 AVALANCHE MEASUREMENT CIRCUIT

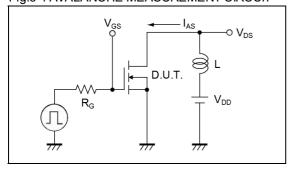


Fig.1-2 Switching Waveforms

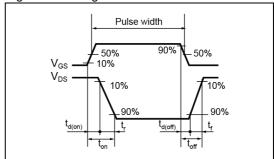


Fig.2-2 Gate Charge Waveform

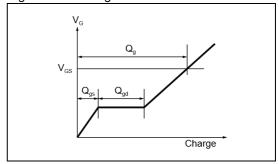
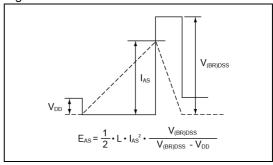
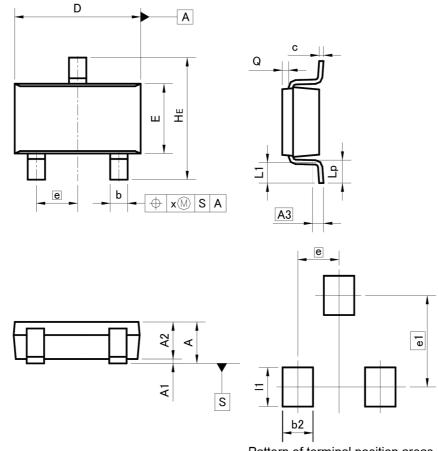


Fig.3-2 AVALANCHE WAVEFORM



#### Dimensions

TSMT3



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM -	MILIM	ETERS	INC	HES
DIIVI	MIN	MAX	MIN	MAX
Α	-	1.00	-	0.039
A1	0.00	0.10	0.000	0.004
A2	0.75	0.95	0.030	0.037
A3	0.	25	0.0	10
b	0.35	0.50	0.014	0.020
С	0.10	0.26	0.004	0.010
D	2.80	3.00	0.110	0.118
Е	1.50	1.80	0.059	0.071
е	0.	95	0.0	37
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.05	0.25	0.002	0.010
x	_	0.20	-	0.008

DIM -	MILIM	MILIMETERS		HES
DIN	MIN	MAX	MIN	MAX
b2		0.70	-	0.028
e1	2.	10	0.0	083
11	-	0.90	-	0.035

Dimension in mm/inches



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